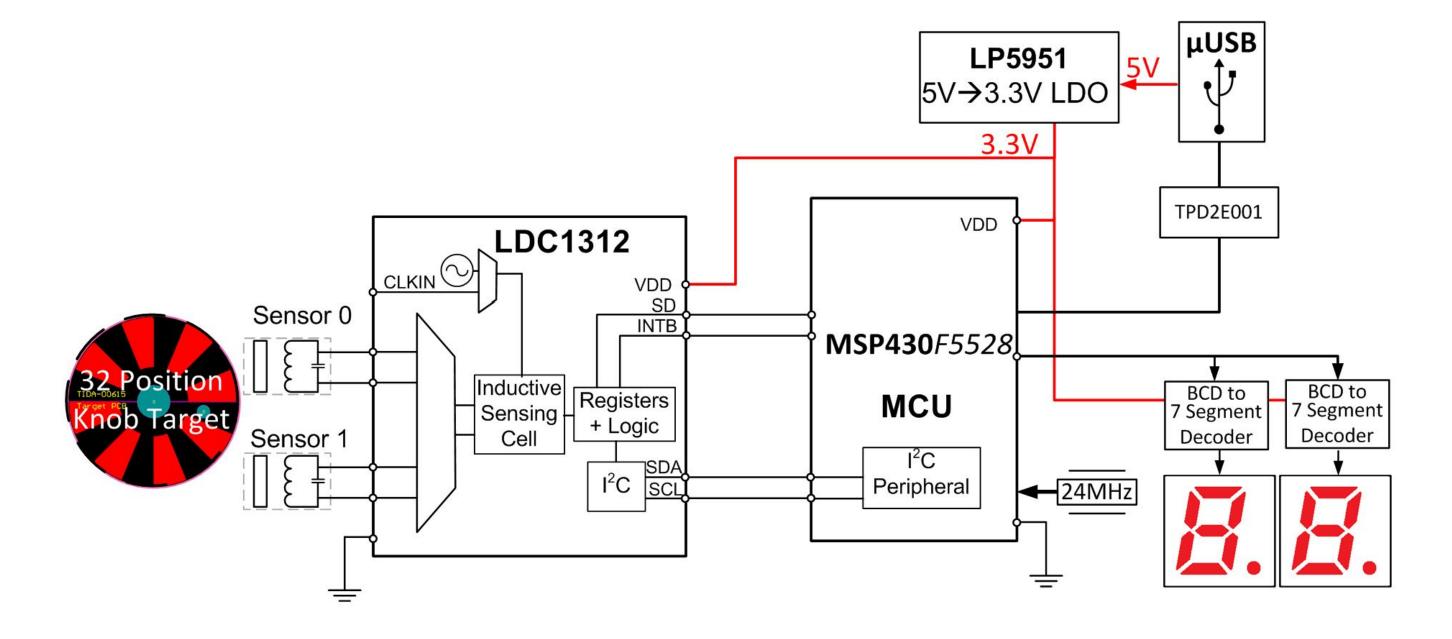
Revision History

 Rev
 ECN #
 Approved Date
 Approved by
 Notes

 N/A
 N/A
 N/A
 N/A
 N/A

TIDA-00615: LDC1312 Incremental Encoder Knob



Orderable: N/A	Designed for: Public Release	Mod. Date: 1/27/2016
TID #: TIDA-00615	Project Title: LDC Encoder Knob	
Number: TIDA-00615	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 3
Drawn By:	File: CoverSheet.SchDoc	Size: B

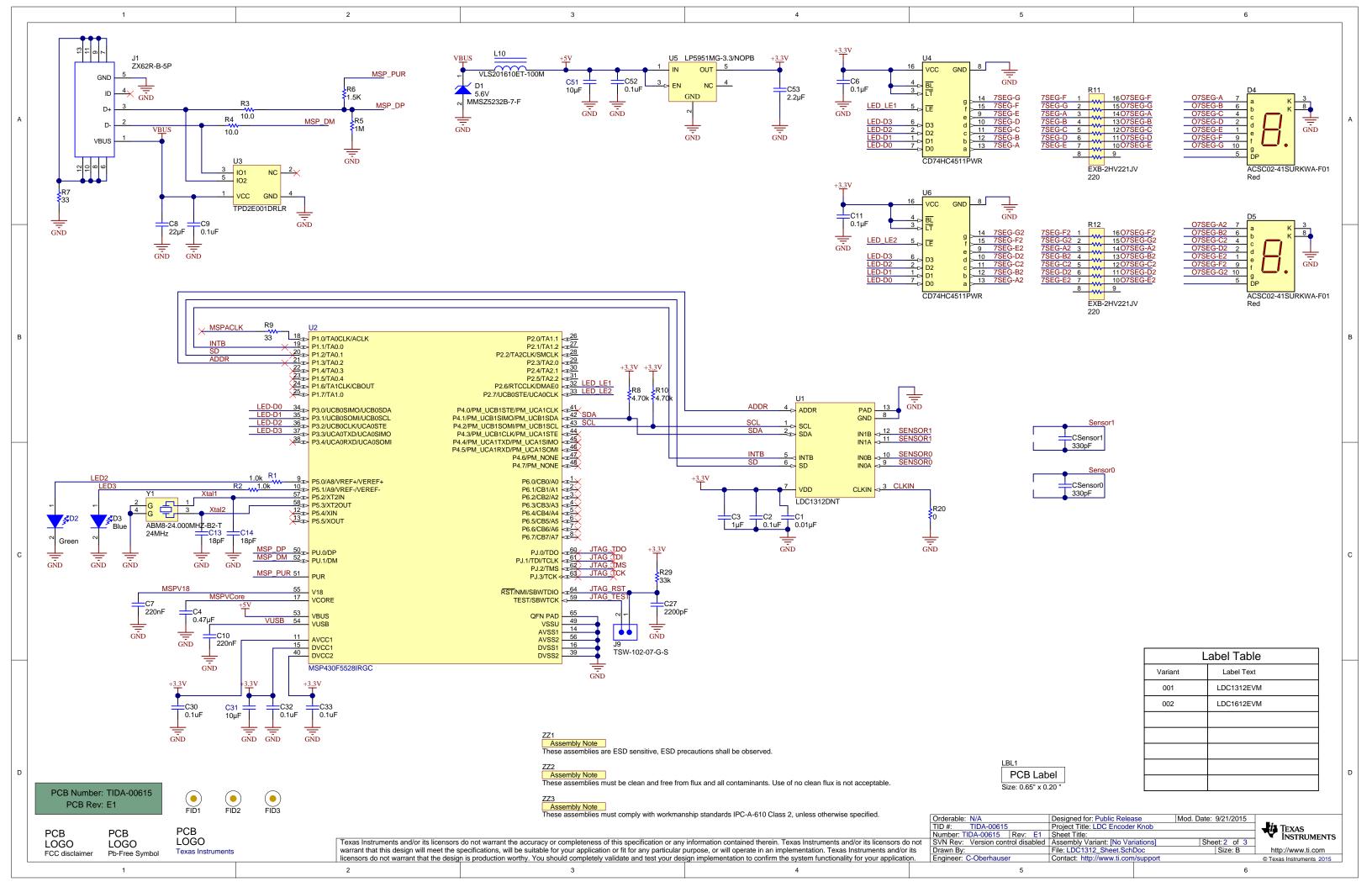
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